

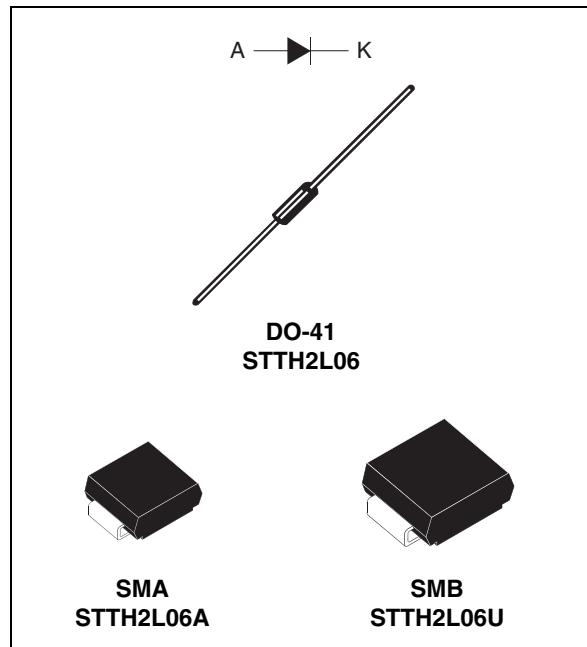
## High efficiency ultrafast diode

### Features

- Very low conduction losses
- Negligible switching losses
- Low forward and reverse recovery times
- High junction temperature

### Description

The STTH2L06 is using ST Turbo 2 600 V planar Pt doping technology. It is specially suited for SMPS and base drive transistor circuits. Packaged in axial, SMA and SMB, this device is intended for use in high frequency inverters, free wheeling and polarity protection.



**Table 1. Device summary**

Symbol	Value
$I_{F(AV)}$	2 A
$V_{RRM}$	600 V
$T_j$	175 °C
$V_F(\text{typ})$	0.85 V
$t_{rr} (\text{max})$	60 ns

# 1 Characteristics

**Table 2. Absolute ratings (limiting values)**

Symbol	Parameter			Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage			600	V
$I_{F(RMS)}$	Forward rms current			7	A
$I_{F(AV)}$	Average forward current, $\delta = 0.5$	DO-41	$T_I = 90^\circ\text{C}$	2	A
		SMA	$T_I = 100^\circ\text{C}$	2	
		SMB	$T_I = 115^\circ\text{C}$	2	
$I_{FSM}$	Surge non repetitive forward current	DO-41	$t_p = 10 \text{ ms}$ sinusoidal	45	A
		SMA / SMB		35	
$T_{sig}$	Storage temperature range			-65 to + 175	°C
$T_j$	Maximum operating junction temperature			175	°C

**Table 3. Thermal resistance**

Symbol	Parameter	Maximum	Unit
$R_{th(j-l)}$	Junction to lead	DO-41 L = 5 mm	35
		SMA	30
		SMB	25

**Table 4. Static electrical characteristics**

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25^\circ\text{C}$	$V_R = V_{RRM}$			2	μA
		$T_j = 150^\circ\text{C}$			12	85	
$V_F^{(2)}$	Forward voltage drop	$T_j = 25^\circ\text{C}$	$I_F = 2 \text{ A}$			1.3	V
		$T_j = 150^\circ\text{C}$			0.85	1.05	

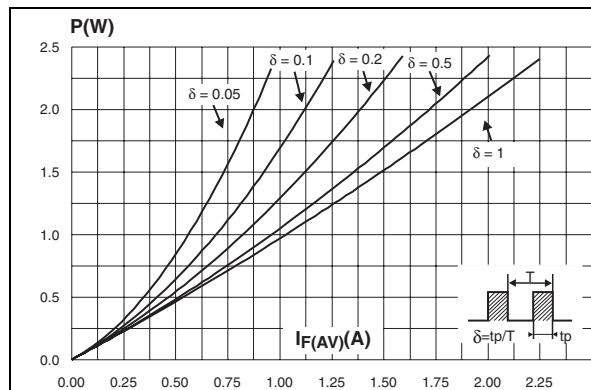
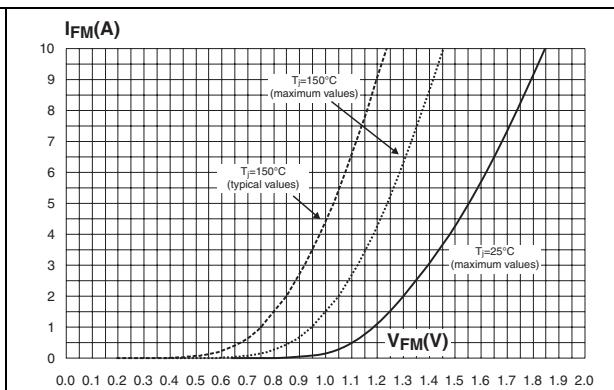
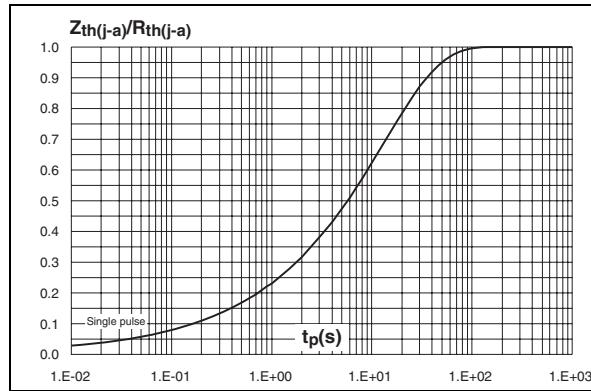
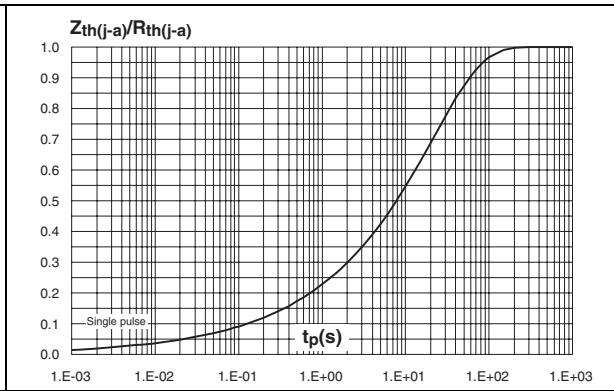
1. Pulse test:  $t_p = 5 \text{ ms}$ ,  $\delta < 2 \%$ 2. Pulse test:  $t_p = 380 \mu\text{s}$ ,  $\delta < 2 \%$ 

To evaluate the maximum conduction losses use the following equation:

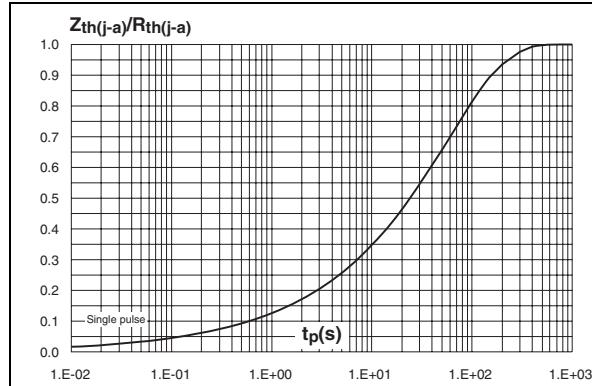
$$P = 0.89 \times I_{F(AV)} + 0.08 I_{F(RMS)}^2$$

**Table 5. Dynamic electrical characteristics**

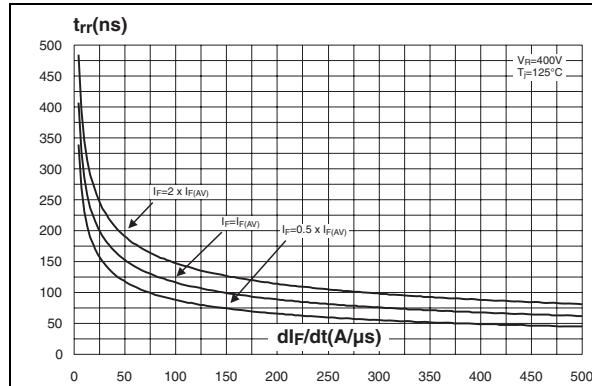
Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
$t_{rr}$	Reverse recovery time	$T_j = 25^\circ\text{C}$	$I_F = 1 \text{ A}$ , $dI_F/dt = 50 \text{ A}/\mu\text{s}$ , $V_R = 30 \text{ V}$		60	85	ns
$t_{fr}$	Forward recovery time	$T_j = 25^\circ\text{C}$	$I_F = 2 \text{ A}$			100	ns
$V_{FP}$	Forward recovery voltage		$dI_F/dt = 100 \text{ A}/\mu\text{s}$ $V_{FR} = 1.1 \times V_{F\max}$			9	V

**Figure 1. Conduction losses vs average forward current****Figure 2. Forward voltage drop vs forward current****Figure 3. Relative variation of thermal impedance junction to case vs pulse duration (SMA -  $S_{CU} = 1 \text{ cm}^2$ )****Figure 4. Relative variation of thermal impedance junction to case vs pulse duration (SMB -  $S_{CU} = 1 \text{ cm}^2$ )**

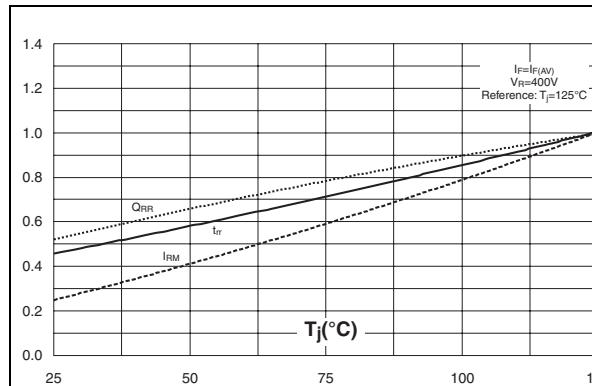
**Figure 5. Relative variation of thermal impedance junction to case vs pulse duration (DO-41)**



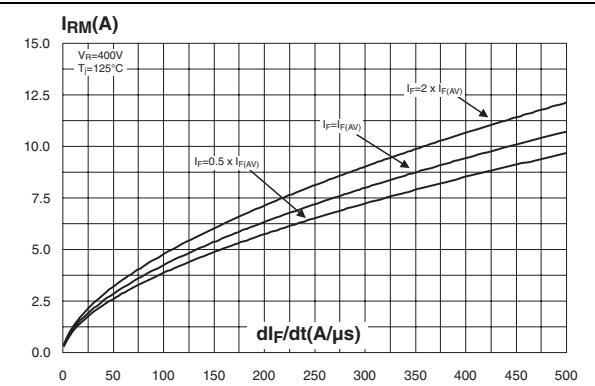
**Figure 7. Reverse recovery time vs  $dI_F/dt$  (typical values)**



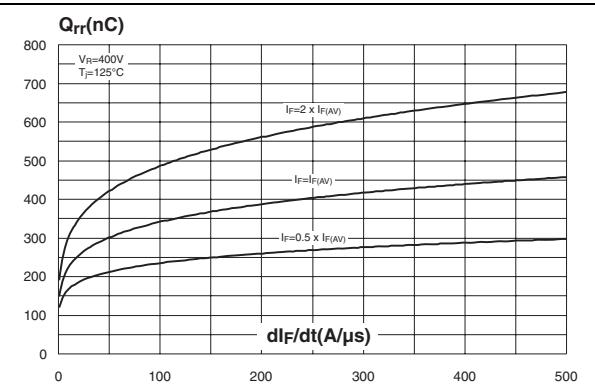
**Figure 9. Relative variations of dynamic parameters vs junction temperature**



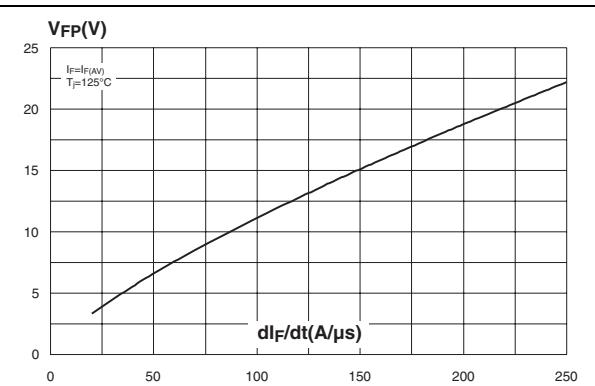
**Figure 6. Peak reverse recovery current vs  $dI_F/dt$  (typical values)**



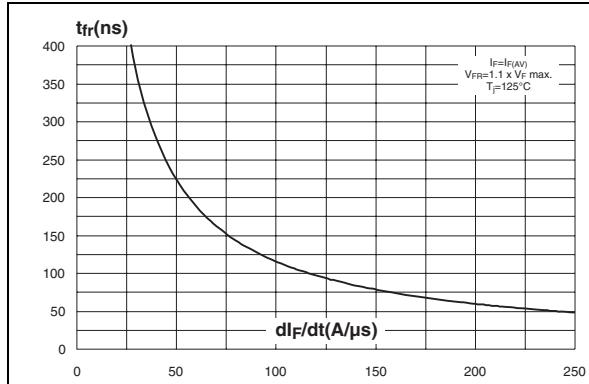
**Figure 8. Reverse recovery charges vs  $dI_F/dt$  (typical values)**



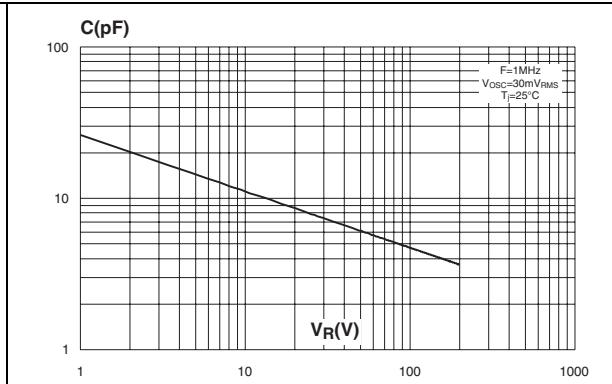
**Figure 10. Transient peak forward voltage vs  $dI_F/dt$  (typical values)**



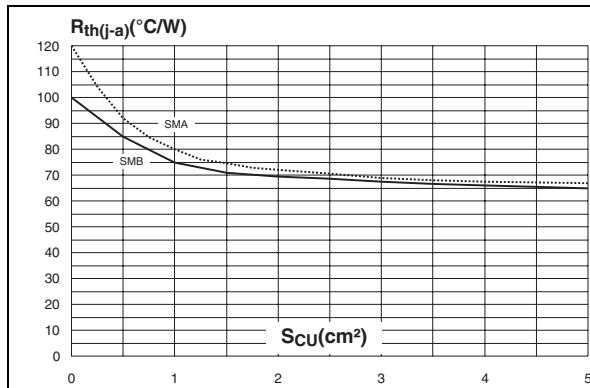
**Figure 11. Forward recovery time vs  $dI_F/dt$  (typical values)**



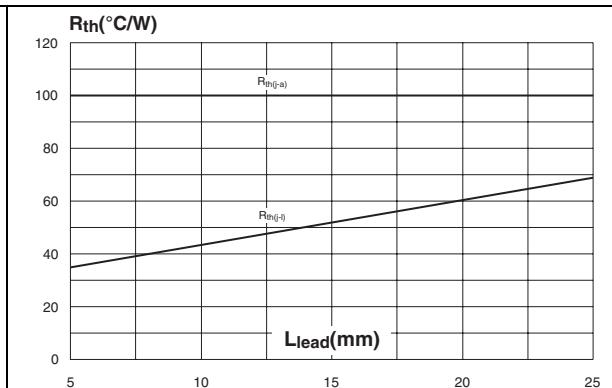
**Figure 12. Junction capacitance vs reverse voltage applied (typical values)**



**Figure 13. Thermal resistance junction to ambient vs copper surface under tab (epoxy FR4, Cu = 35  $\mu m$ )**



**Figure 14. Thermal resistance vs lead length (DO-41)**



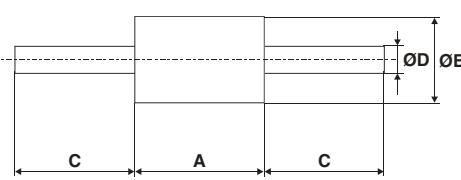
## 2 Package information

- Epoxy meets UL 94, V0
- Band indicates cathode
- Bending method (DO-41): see Application note AN1471

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).  
ECOPACK® is an ST trademark.

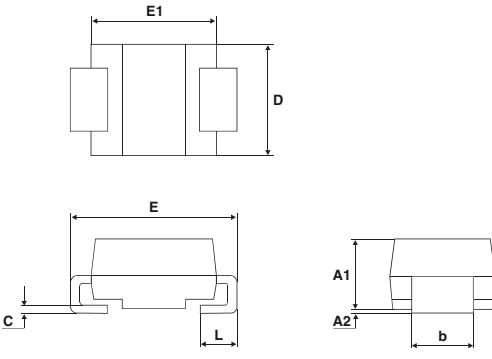
**Table 6. DO-41 (plastic) dimensions**

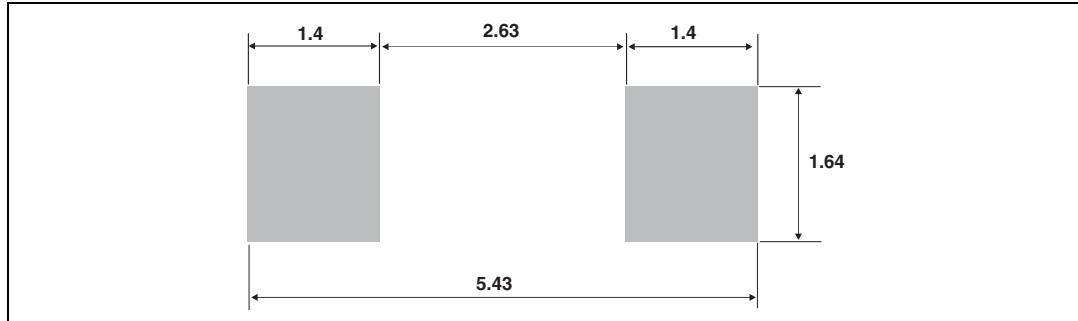
Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.07	5.20	0.160	0.205
B	2.04	2.71	0.080	0.107
C	25.4		1	
D	0.71	0.86	0.028	0.034



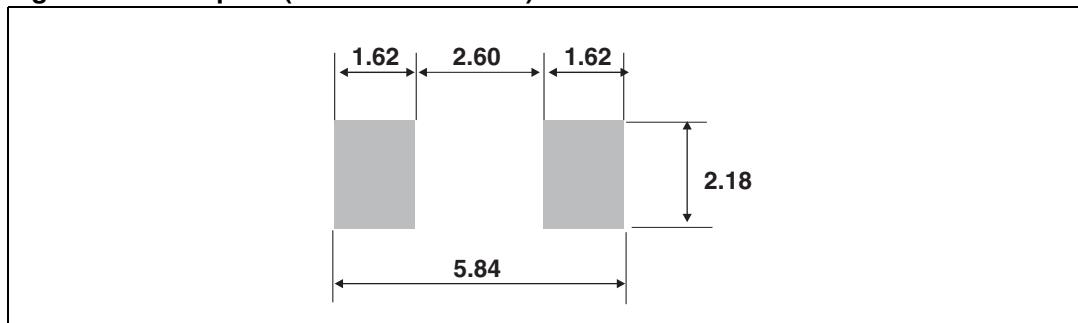
**Table 7. SMA dimensions**

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.094
A2	0.05	0.20	0.002	0.008
b	1.25	1.65	0.049	0.065
c	0.15	0.40	0.006	0.016
D	2.25	2.90	0.089	0.114
E	4.80	5.35	0.189	0.211
E1	3.95	4.60	0.156	0.181
L	0.75	1.50	0.030	0.059



**Figure 15. Footprint (dimensions in mm)****Table 8. SMB dimensions**

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	1.95	2.20	0.077	0.087
c	0.15	0.40	0.006	0.016
D	3.30	3.95	0.130	0.156
E	5.10	5.60	0.201	0.220
E1	4.05	4.60	0.159	0.181
L	0.75	1.50	0.030	0.059

**Figure 16. Footprint (dimensions in mm)**

### 3 Ordering information

**Table 9. Ordering information**

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH2L06	STTH2L06	DO-41	0.34 g	2000	Ammopack
STTH2L06RL	STTH2L06	DO-41	0.34 g	5000	Tape and reel
STTH2L06A	L6A	SMA	0.068 g	5000	Tape and reel
STTH2L06U	L6U	SMB	0.11 g	2500	Tape and reel

### 4 Revision history

**Table 10. Document revision history**

Date	Revision	Changes
07-Sep-2004	1	First issue.
30-Sep-2009	2	Updated table 6 package dimensions.

**Please Read Carefully:**

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

**UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.**

**UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.**

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2009 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

[www.st.com](http://www.st.com)





Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

#### Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помошь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помошь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: [org@eplast1.ru](mailto:org@eplast1.ru)

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.